

# SKKT 172, SKKH 172



SEMIPACK® 2

## Thyristor / Diode Modules

SKKH 172

SKKT 172

### Features

- Heat transfer through aluminium oxide ceramic isolated metal baseplate
- Hard soldered joints for high reliability
- UL recognized, file no. E 63 532

### Typical Applications\*

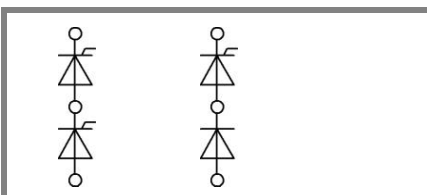
- DC motor control (e.g. for machine tools)
- AC motor soft starters

1) Characteristic values

2) See the assembly instructions

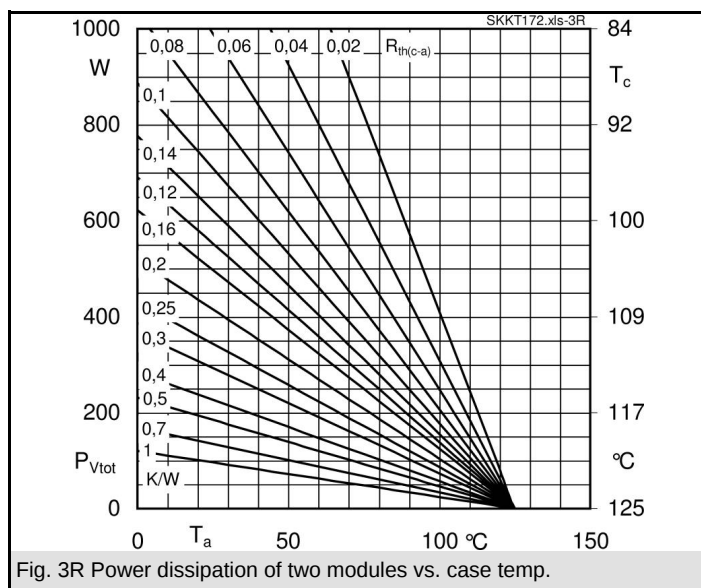
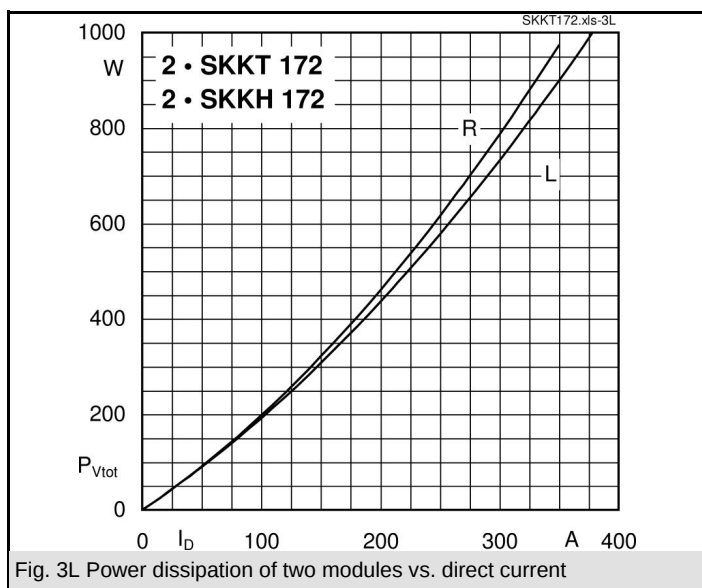
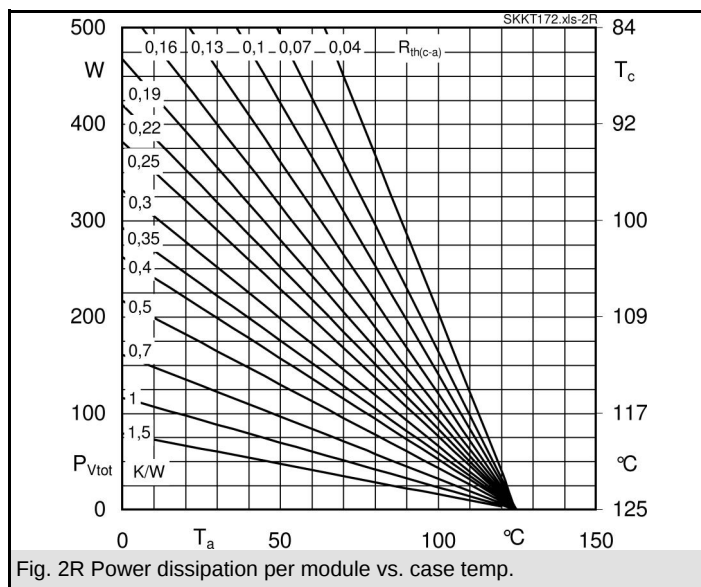
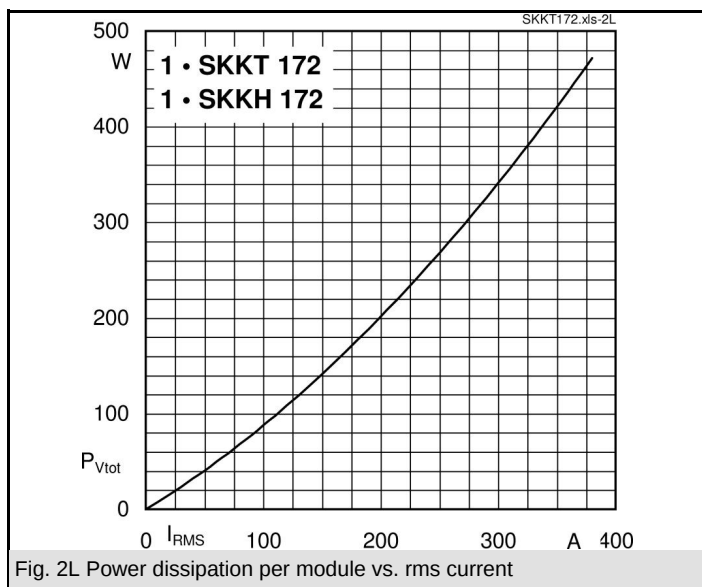
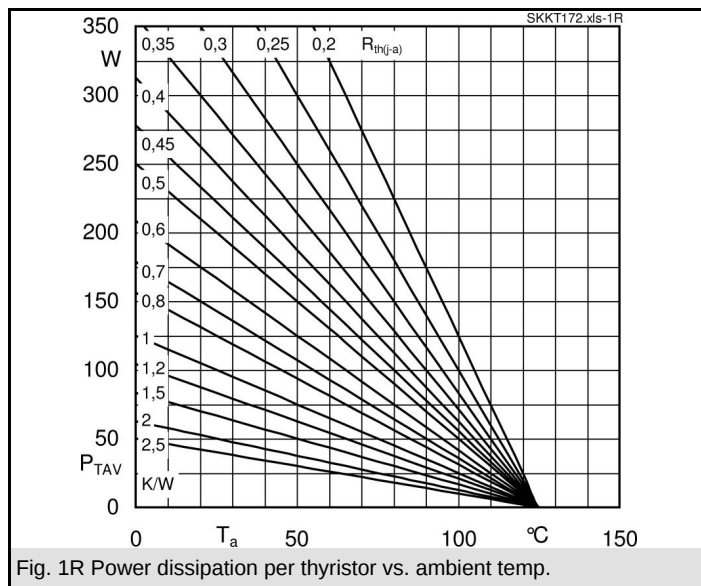
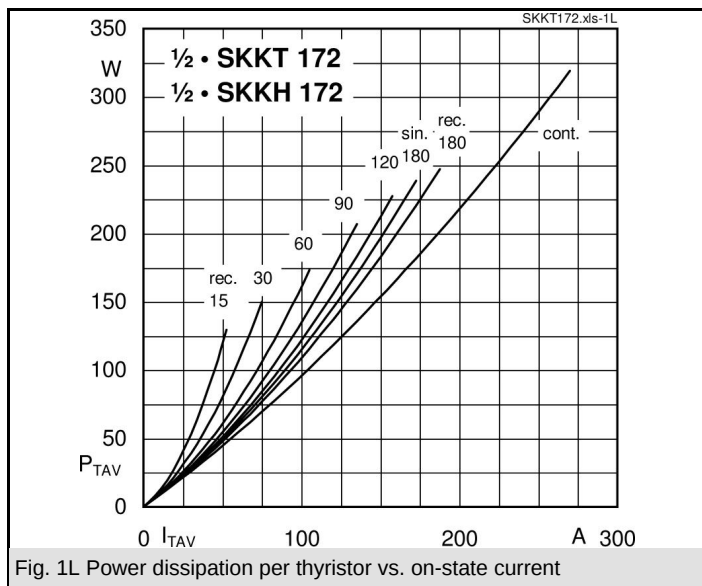
| $V_{RSM}$<br>V | $V_{RRM}, V_{DRM}$<br>V | $I_{TRMS} = 275$ A (maximum value for continuous operation)<br>$I_{TAV} = 172$ A (sin.180; $T_c = 86$ °C) |              |  |
|----------------|-------------------------|-----------------------------------------------------------------------------------------------------------|--------------|--|
| 1500           | 1400                    | SKKT 172/14E                                                                                              | SKKH 172/16E |  |
| 1700           | 1600                    | SKKT 172/16E                                                                                              |              |  |
| 1900           | 1800                    | SKKT 172/18E                                                                                              |              |  |

| Symbol               | Conditions                                                          | Values                 | Units      |
|----------------------|---------------------------------------------------------------------|------------------------|------------|
| $I_{TAV}$            | sin. 180; $T_c = 85$ (100) °C;                                      | 175 (124 )             | A          |
| $I_{TSM}$            | $T_{vj} = 25$ °C; 10 ms<br>$T_{vj} = 125$ °C; 10 ms                 | 5400<br>5000           | A<br>A     |
| $i^2t$               | $T_{vj} = 25$ °C; 8,3 ... 10 ms<br>$T_{vj} = 125$ °C; 8,3 ... 10 ms | 145000<br>125000       | A²s<br>A²s |
| $V_T$                | $T_{vj} = 25$ °C; $I_T = 500$ A                                     | max. 1,41              | V          |
| $V_{T(TO)}$          | $T_{vj} = 125$ °C                                                   | max. 0,83              | V          |
| $r_T$                | $T_{vj} = 125$ °C                                                   | max. 1,3               | mΩ         |
| $V_{T(TO)}(typ.)^1)$ | $T_{vj} = 125$ °C                                                   | 0,8                    | V          |
| $r_T(typ.)^1)$       | $T_{vj} = 125$ °C                                                   | 1,2                    | mΩ         |
| $I_{DD}, I_{RD}$     | $T_{vj} = 125$ °C; $V_{RD} = V_{RRM}, V_{DD} = V_{DRM}$             | max. 40                | mA         |
| $t_{gd}$             | $T_{vj} = 25$ °C; $I_G = 1$ A; $di_G/dt = 1$ A/μs                   | 1                      | μs         |
| $t_{gr}$             | $V_D = 0,67 * V_{DRM}$                                              | 2                      | μs         |
| $(di/dt)_{cr}$       | $T_{vj} = 125$ °C                                                   | max. 200               | A/μs       |
| $(dv/dt)_{cr}$       | $T_{vj} = 125$ °C                                                   | max. 1000              | V/μs       |
| $t_q$                | $T_{vj} = 125$ °C ,                                                 | typ. 175               | μs         |
| $I_H$                | $T_{vj} = 25$ °C; typ. / max.                                       | 150 / 400              | mA         |
| $I_L$                | $T_{vj} = 25$ °C; $R_G = 33$ Ω; typ. / max.                         | 300 / 1000             | mA         |
| $V_{GT}$             | $T_{vj} = 25$ °C; d.c.                                              | min. 2                 | V          |
| $I_{GT}$             | $T_{vj} = 25$ °C; d.c.                                              | min. 150               | mA         |
| $V_{GD}$             | $T_{vj} = 125$ °C; d.c.                                             | max. 0,25              | V          |
| $I_{GD}$             | $T_{vj} = 125$ °C; d.c.                                             | max. 10                | mA         |
| $R_{th(j-c)}$        | cont.; per thyristor / per module                                   | 0,155 / 0,078          | K/W        |
| $R_{th(j-c)}$        | sin. 180; per thyristor / per module                                | 0,164 / 0,082          | K/W        |
| $R_{th(j-c)}$        | rec. 120; per thyristor / per module                                | 0,18 / 0,09            | K/W        |
| $R_{th(c-s)}$        | per thyristor / per module                                          | 0,1 / 0,05             | K/W        |
| $T_{vj}$             |                                                                     | - 40 ... + 125         | °C         |
| $T_{stg}$            |                                                                     | - 40 ... + 125         | °C         |
| $V_{isol}$           | a. c. 50 Hz; r.m.s.; 1 s / 1 min.                                   | 3600 / 3000            | V~         |
| $M_s$                | to heatsink                                                         | 5 ± 15 % <sup>2)</sup> | Nm         |
| $M_t$                | to terminal                                                         | 5 ± 15 %               | Nm         |
| $a$                  |                                                                     | 5 * 9,81               | m/s²       |
| $m$                  | approx.                                                             | 165                    | g          |
| Case                 | SKKT<br>SKKH                                                        | A 21<br>A 22           |            |

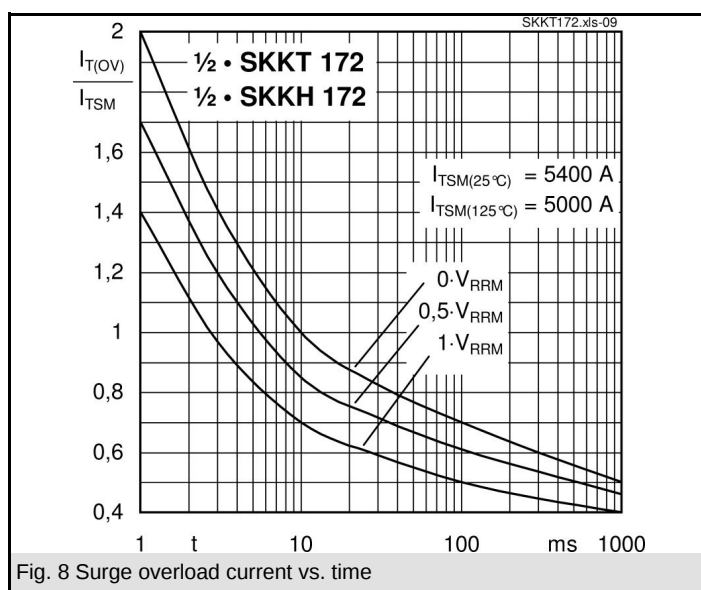
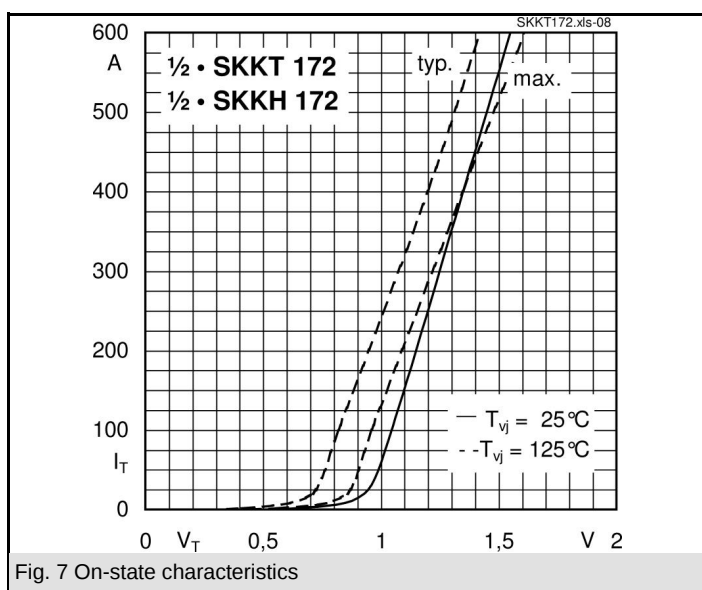
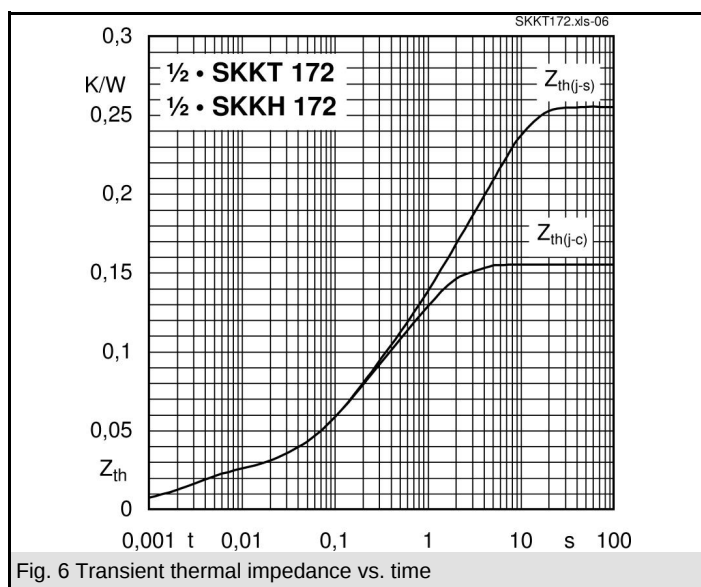
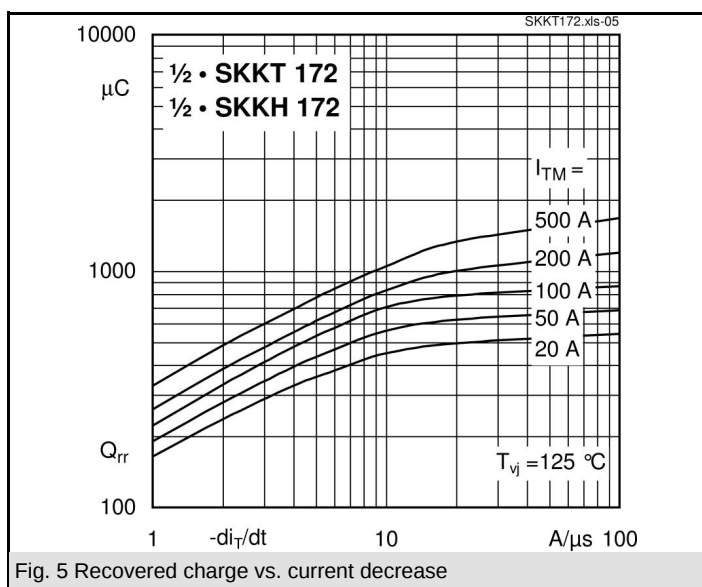
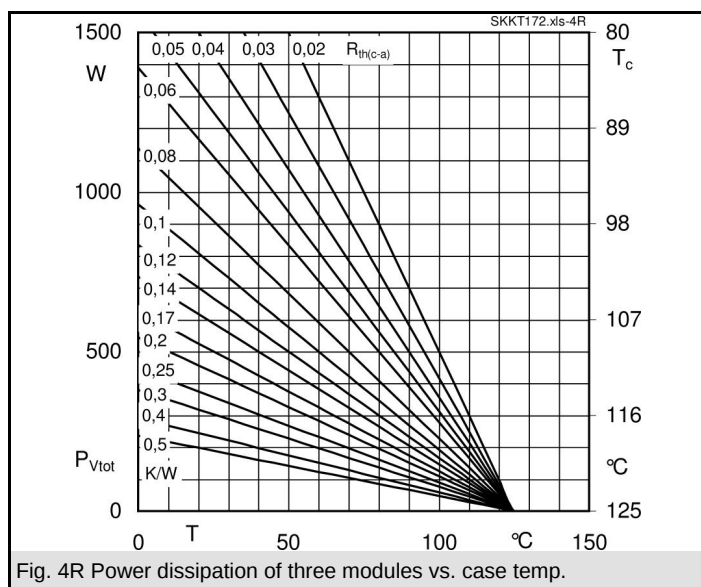
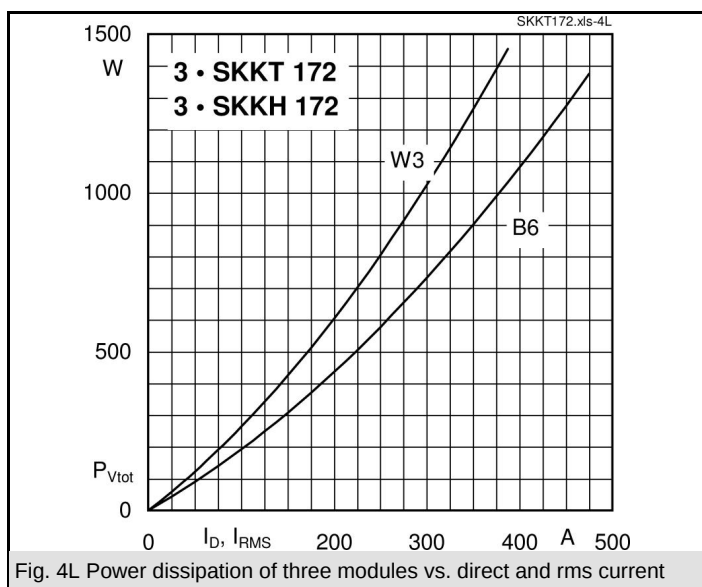


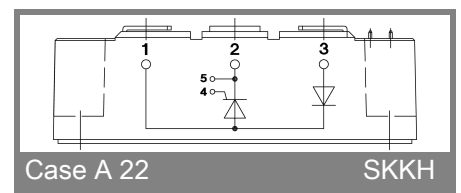
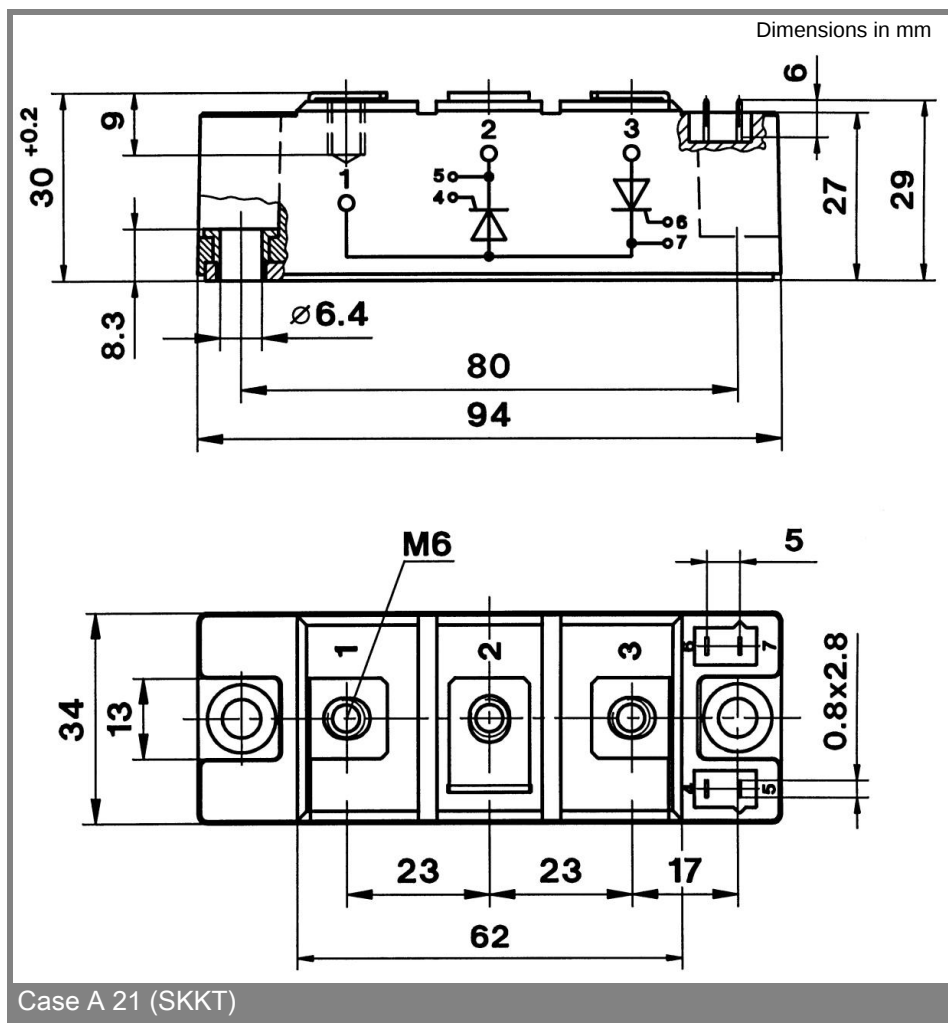
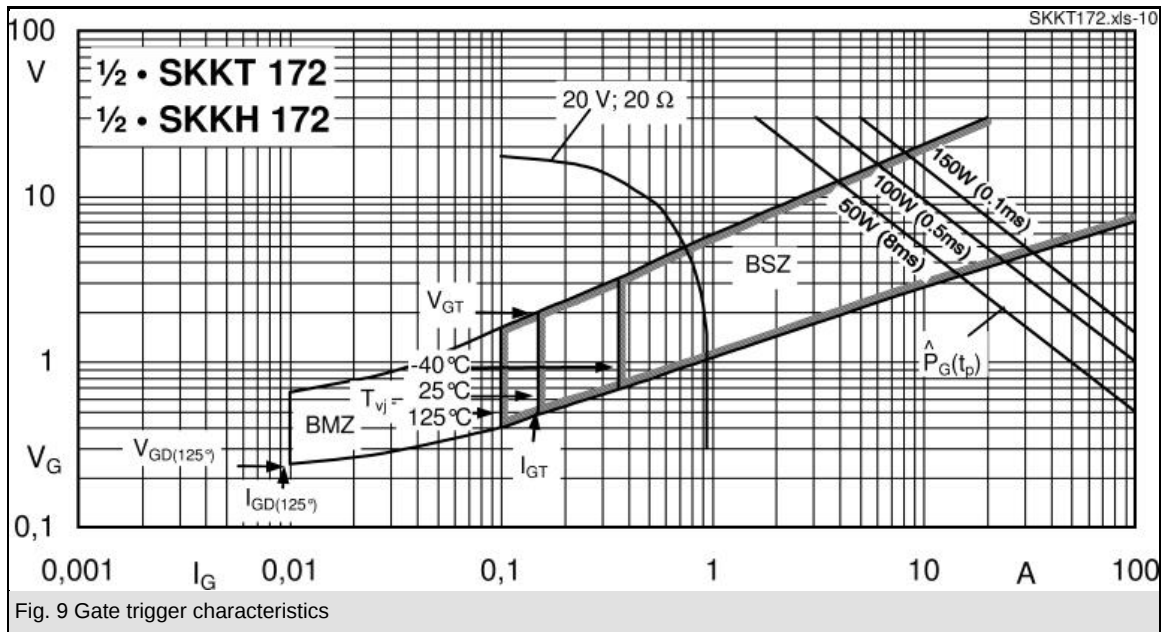
SKKT

SKKH



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\* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON

products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.